

# Detector fabrication development for the LiteBIRD satellite mission

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## ABSTRACT

LiteBIRD is a JAXA-led strategic Large-Class satellite mission designed to measure the polarization of the cosmic microwave background and cosmic foregrounds from 34 to 448 GHz across the entire sky from L2 in the late 2020's. The primary focus of the mission is to measure primordially generated B-mode polarization at large angular scales. Beyond its primary scientific objective LiteBIRD will generate a data-set capable of probing a number of scientific inquiries including the sum of neutrino masses. The primary responsibility of United States will be to fabricate the three flight model focal plane units for the mission. The design and fabrication of these focal plane units is driven by heritage from ground based experiments and will include both lenslet-coupled sinuous antenna pixels and horn-coupled orthomode transducer pixels. The experiment will have three optical telescopes called the low frequency telescope, mid frequency telescope, and high frequency telescope each of which covers a portion of the mission's frequency range. JAXA is responsible for the construction of the low frequency telescope and the European Consortium is responsible for the mid- and high- frequency telescopes. The broad frequency coverage and low optical loading conditions, made possible by the space environment, require development and adaptation of detector technology recently deployed

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by other cosmic microwave background experiments. This design, fabrication, and characterization will take place at UC Berkeley, NIST, Stanford, and Colorado University, Boulder. We present the current status of the US deliverables to the LiteBIRD mission.

**Keywords:** SPIE Digital Forum, CMB, Detectors, Space-Mission, Polarization, Inflation, Cosmic Foregrounds, Satellite, LiteBIRD

## 1. INTRODUCTION

LiteBIRD is a JAXA-led strategic Large-Class satellite mission that will map the polarization of the [Cosmic Microwave Background \(CMB\)](#) and cosmic foreground over the entire sky with an angular resolution appropriate to cover the multipole range  $2 \leq \ell \leq 200$ . The payload consists of three telescopes called the [Low-Frequency Telescope \(LFT\)](#), [Mid-Frequency Telescope \(MFT\)](#), [High-Frequency Telescope \(HFT\)](#) each of which has a corresponding [Focal Plane Unit \(FPU\)](#). It is the primary responsibility of the US team to deliver the [flight model \(FM\) FPUs](#) including an [Adiabatic Demagnetization Refrigerator \(ADR\)](#) cooling system for the mission. LiteBIRD will deploy a total of 15 detector bands ranging from 34 to 448 *GHz* which are distributed across the [Low-Frequency Focal Plane Unit \(LF-FPU\)](#), [Mid-Frequency Focal Plane Unit \(MF-FPU\)](#), and [High-Frequency Focal Plane Unit \(HF-FPU\)](#). The [Focal Plane Modules \(FPMs\)](#) for the LF-FPU and MF-FPU consist of lenslet coupled sinuous antenna [Transition-Edge Sensor \(TES\)](#) bolometer arrays with di- and tri-plexing RF filters. The HF-FPU consists of horn coupled [orthomode transducer \(OMT\) TES](#) bolometer arrays with two dichroic arrays and one monochromatic array. An overview of the LiteBIRD mission can be found in a companion SPIE paper<sup>1</sup> and detailed descriptions of the LFT and the [Mid- and High-Frequency Telescopes \(MHFT\)](#) can be found in two other SPIE companion papers as well.<sup>2,3</sup>

The [LF-FPU](#) holds eight square tiles with four distinct pixel types and two distinct [FPM](#) types with a pixel pitch of 32 *mm* for the lowest frequency pixels and 16 *mm* for the higher frequency pixels. The [LF-FPU](#) has a frequency coverage of 34 to 148 *GHz* making it sensitive to both synchrotron radiation and the [CMB](#). The [MF-FPU](#) holds 7 hexagonal tiles and 2 different [FPM](#) types each with a single pixel type for each, but share a common pixel pitch of 12 *mm*. These [FPMs](#) cover the frequency range from 90 to 180 *GHz* and are designed to be most sensitive at [CMB](#) frequencies. The [HF-FPU](#) holds 3 hexagonal [FPMs](#) each with their own pixel type; the two lower frequency [FPMs](#) have a pixel pitch of 7 *mm* and are dichroic, while the highest frequency [FPM](#) has a pixel pitch of 6.1 *mm* and is monochromatic. The total bandwidth of this [FPM](#) is 200 to 448 *GHz* and will be sensitive to the dusty cosmic foregrounds.

The stringent scientific requirements of the LiteBIRD mission flow down to challenging technical specifications for the detection chain. In particular, the [FPU](#)s must have an unmodulated 1/f-knee  $\leq 20$  *mHz* in order to measure the largest angular scales of the [CMB](#). The combined sensitivity of the [FPU](#)s will be 2.16  $\mu\text{K-arcmin}$  with a typical angular resolution of 0.5 at 150 *GHz*. Full success of the LiteBIRD mission would achieve  $\delta r \leq 0.001$ , where  $\delta r$  is the total error on the tensor-to-scalar ratio *r*.

The US team consists of two fabrication sites: the [Marvell Nanofabrication Laboratory \(MNL\)](#) at the [University of California, Berkeley \(UC Berkeley\)](#) and [Boulder Microfabrication Facility \(BMF\)](#) at the [National Institute of Standards and Technologies \(NIST\)](#). Both institutions have extensive heritage in fabricating [TES](#) bolometer arrays for studies of the polarization of the [CMB](#) for both ground-based and balloon-borne experiments making them especially suitable for LiteBIRD. The

MNL is a  $\sim 10,000$  square foot class 100 clean room that has rich heritage of fabricating detectors for CMB experiments including: APEX-SZ, SPT-SZ, EBEX, ASTE-TESCAM, POLARBEAR-1, Simons Array (SA), and Simons Observatory (SO). The BMF is a  $\sim 18,000$  square foot class 100 clean-room that has fabricated detectors for many mm and sub-mm CMB projects including the ACTPol, Advance ACTPol, SPTPol, SPIDER, SO and BLAST. Testing of all of the Low-Frequency (LF), Mid-Frequency (MF), High-Frequency (HF) FPMs will take place at UC Berkeley (LF), University of Colorado, Boulder (CU) (MF), and Stanford University (Stanford) (HF) respectfully. Additional chip and array testing will take place at Kavli Institute for the Physics and Mathematics of the Universe (IPMU), High Energy Accelerator Research Organization in Tsukuba, Japan (KEK), University of Tokyo (U of T) including the validation of other key technological components of LiteBIRD. The entire focal plane will be integrated at UC Berkeley for final characterization prior to flight. In this proceeding, we discuss the current status of the design, fabrication, and testing of these FPUs as part of the US contribution to the LiteBIRD satellite mission.

## 2. US DELIVERABLES

LiteBIRD requires measurements with 15 frequency bands between 34 and 448 GHz to achieve the total sensitivity of  $\mu\text{K-arcmin}$  with three years of observations. In order to meet this requirement, these 15 bands are distributed throughout three different FPU in three different telescopes with 9 distinct pixel types for the mission (see Table 1 for more details on the LiteBIRD bands). As shown in figure 1, the shapes of the FPU are matched to the illumination patterns of their respective telescopes.

### 2.1 Focal Plane Units

LiteBIRD will deploy a FPU for each of the telescopes, and are named after each telescope respectively: LF-FPU, MF-FPU, and the HF-FPU. The details of the distribution of the mission's 15 bands and pixel counts in shown in table 1 and CAD diagrams of each FPU is shown in figure 2. The details of each FPU are discussed in sections 2.3, 2.4, and 2.5.

Generally speaking the three FPUs share a common architecture. A Focal Plane Structure (FPS) provides thermal insulation from the Joule-Thomson 5 K (JT5) cooled stage and thermal connection to the Adiabatic Demagnetization Refrigerator that cools the Sub-Kelvin stages (Sub-K ADR) in order to operate an array of individual FPMs at 100 mK. The telescope designs drive the focal plane layouts; the LFT FPU is rectangular to match the oblong illumination pattern of the crossed Dragone telescope design while the MFT and HFT FPUs are hexagonal arrays which pack the pixels most efficiently into the the axis-symmetric MFT and HFT refractor telescopes.

### 2.2 Focal Plane Modules

The FPMs of LiteBIRD are filled with arrays of antenna-coupled TES fabricated on silicon wafers coupled to a multiplexed readout system. Each FPM consists of a single detector array, optical coupling hardware (lenslet or horn arrays, backshort wafers, etc.), the Cryogenic Readout Units (CRU), and mechanical structures which hold these parts together and provide an interface to the FPS as shown in figure 3.

#### 2.2.1 Optical Coupling

The electromagnetic coupling structures for each focal plane were chosen based on our analysis of what the most appropriate technology for the specific frequency ranges. The LFT and MFT FPMs share a common architecture of lenslet-coupled sinuous antenna arrays and the HFT FPMs use horn-coupled OMT arrays. Both technologies sense orthogonal polarizations simultaneously and are

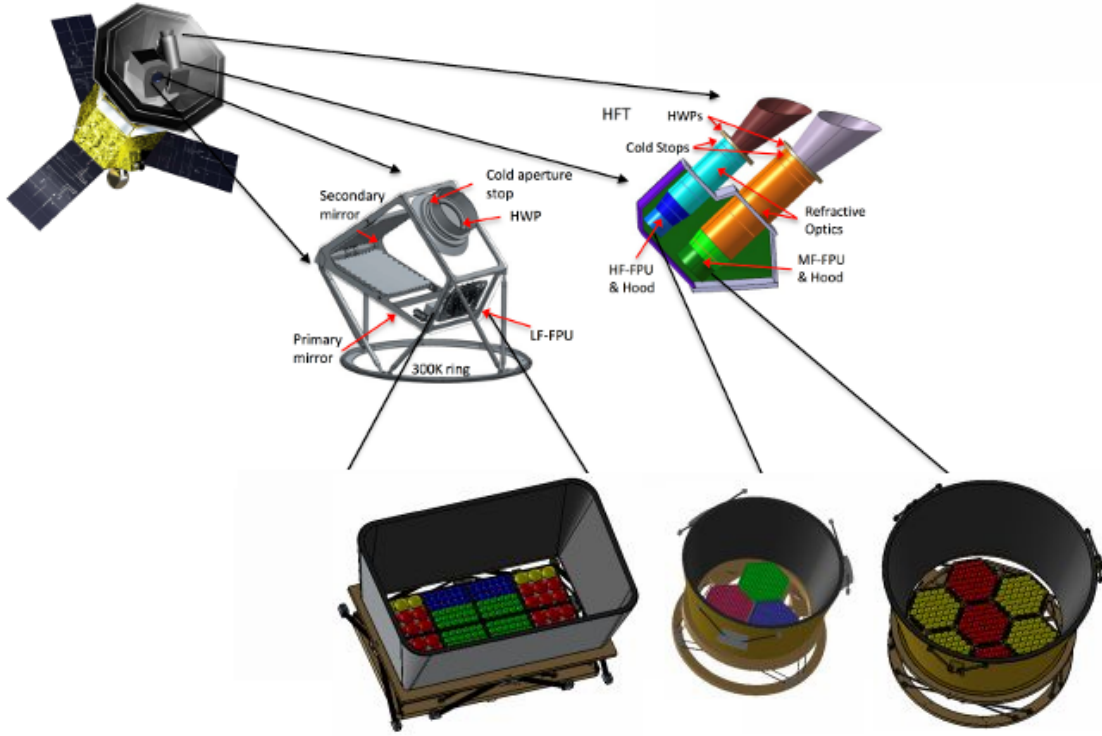


Figure 1. The optical layout of the LiteBIRD experiment. The crossed Dragone reflector design of the [LFT](#) yields an oblong [FOV](#) which lead to the rectangular tiled 8 [FPM](#) design as shown above. The [MHFT](#) consists of two axially symmetric refractive optics tubes that couple well to close-hex packed [FPMs](#).

coupled to on-chip micro-strip bandpass filters which split the signal into one, two, or three frequency bands. The power from each frequency and polarization propagate along superconducting micro-strip lines where it is then dissipated on thermally isolated [TES](#) bolometer islands. [TES](#) electrical bias lines carry the induced signal to the edge of the silicon wafer where it is wire-bonded to a flexible circuit leading to the cold readout. The [TES](#) technology is able to reach the instantaneous sensitivity required by the LiteBIRD mission and is a mature technology with well-established use in ground-based and sub-orbital [CMB](#) experiments.<sup>4-8</sup> Details of each type of optical coupling are shown in figure 4.

### 2.2.2 Structure

The [FPSs](#) each contain two intermediate temperature stages at 1.8 *K* and 300 *mK* between the [FPU](#)s at 100 *mK* and the 4.8 *K* telescope structures. A free-space low pass edge filter and a [Focal Plane Hood \(FPH\)](#) are supported by the 1.8 *K* stage. Aluminized thin film spans the interstage gaps to block radio frequency and residual warm thermal radiation. The requirements include a thermal budget for each stage and mechanical performance to survive launch loads and keep resonances clear of the science band while in operation. Our current baseline includes aluminum, titanium, and copper metallic parts and carbon fiber reinforced plastic inter-stage support struts. A trade-off study is in progress to determine whether struts can be designed to be able to survive



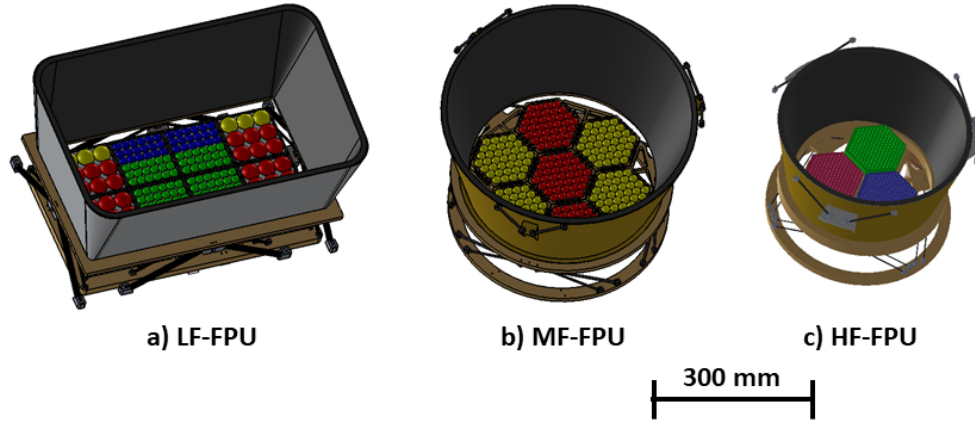


Figure 2. The LF, MF, and HF FPUs. The LF-FPU rectangular shape is matched to the LFT's oblong FOV using square FPM tiles. The mid and high frequency telescopes both have circular FOVs and therefore employ hexagonal arrays arranged in close hex pattern. The pixels types are color code and the details of each can be found in table 1

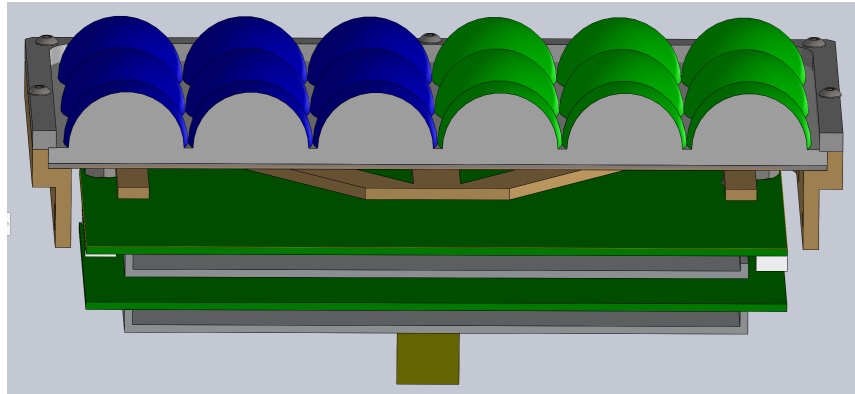


Figure 3. A cross sectional diagram of a LF-4 FPM. These particular FPMs have two distinct pixel types which are color coded as green (LB-3) and blue (LF-4). These FPMs are the central four tiles of the LF-FPU. The silicon hemispheres will have laser-drilled holes that form a broadband AR surface. The detector array is mounted with its backside flush to the back side of the lenslet array. A free-space optical filter is situated over each focal plane, attached to the detector hoods, not shown in these figures. The mechanical structure is constructed with invar to match the CTE of the silicon in the lenslets and feedhorn arrays. Flexible circuitry connect the bond pads at the edge of the wafer to the CRU which is also cooled to 100 mK.

launch loads without launch locks.

### 2.3 LF-FPU

The LF-FPU has a FOV of  $\geq 18^\circ \times 9^\circ$  with a typical beam size of  $\sim 1$  degree. The crossing angle of  $90^\circ$  and the F#3.0 were chosen to minimize the effects of stray light, especially at the edges of the FOV. To further mitigate this effect we place the lowest frequency pixels in LiteBIRD which are

Telescope	Detector Type	FPM	Pixel Name	Frequency [GHz]	Frequency Range [GHz]	Pixel Size (mm)	Pixel Count	$N_{det}$
LFT	Lenslet/ Sinuous	LF12	LF-1	40/60/78	34 - 87 ( $\Delta 53$ )	32	12	72
			LF-2	50/68/89	43 - 99 ( $\Delta 56$ )	32	24	144
		LF34	LF-3	68/89/119	60 - 133 ( $\Delta 73$ )	16	72	432
			LF-4	78/100/140	69 - 162 ( $\Delta 93$ )	16	72	432
MFT	Lenslet/ Sinuous	MF1	MF-1	100/140/195	77 - 224 ( $\Delta 147$ )	12	183	1098
		MF2	MF-2	119/166	105 - 216 ( $\Delta 111$ )	12	244	976
HFT	Horn/ OMT	HF1	HF-1	195/280	166 - 322 ( $\Delta 156$ )	7	127	508
		HF2	HF-2	235/337	200 - 388 ( $\Delta 188$ )	7	127	508
		HF3	HF-3	402	366 - 448 ( $\Delta 92$ )	6.1	169	338

Table 1. Focal plane configurations for the **LF-FPU**, **MF-FPU**, and **HF-FPU**. The colors of the frequency schedule correspond to those in figure 2. The detector count is simply the pixel count multiplied by the number of bands in the pixel and the two orthogonal polarization states sense by each pixel.

the yellow pixels in the left hand side of figure 2. The large pixel spacing allows for excellent Lyot efficiency which further optimizes the **LF-FPU** for the science goals of LiteBIRD.

The **LF-FPU** has total of eight 140 mm x 140 mm square tiles arranged in a rectangular 4x2 array. There are two unique types of **FPMs** in the **LF-FPU** that will contain four pixel types called LF-1 (yellow), -2 (red), -3 (blue), and -4 (green). The indexing corresponds with the average frequency of a given pixel type. Table 1 shows the individual specifications for the pixels in these **FPMs** shown in 2. Three LF-1 (40/60/78 GHz) and six LF-2 (50/60/78 GHz) pixels are distributed on a 9-pixel **FPM** with a pixel pitch of 32 mm. The LF-1 (i.e. the lowest frequency) pixels are placed at the edges of the **LF-FPU** to minimize the impacts of scattered light on optical performance. The LF-3 (68/89/119 GHz) and LF-4 (78/100/140 GHz) bands are distributed equally in each of four **LF FPU**s. These **FPU**s have a pixel pitch of 16 mm and have 18 LF-3 and 18 LF-4 pixels each. We oriented the **FPU**s such that the highest average frequency pixels are in the central region of the focal plane.

## 2.4 MF-FPU

The **MFT** is an axially symmetric refractor telescope with a **FOV** of  $\sim 28^\circ$  with  $F\#=2.2$  with an aperture stop of 300 mm. There are 2 unique types of **FPMs** that will go into the **MF-FPU**, which we refer to as MF-1 (100/140/195 GHz), and MF-2 (119/166 GHz). Both **FPMs** have a pixel pitch of 12 mm. There are three MF-1 and four MF-2 modules in the **MF-FPU**.

## 2.5 HF-FPU

The design of the **HFT** is essentially compact version of the **HFT**; it is also an axially symmetric refractor telescope with a **FOV** of  $\sim 28^\circ$  with  $F\#=2.2$  but has aperture stop of 200 mm. There are 3 unique types of **FPMs** that will go into the **HF-FPU**, which we refer to as HF-1, HF-2, HF-3 all of which are horn-coupled **OMT** detectors described in section 3.2.1 and have an architecture very similar to that of.<sup>6,8</sup> The HF-1 and HF-2 are dichroic pixels with band centered on 195/280 GHz and 235/337 GHz respectively. The highest frequency **FPM** of LiteBIRD HF-3 has monochromatic pixels with bands centered at 402 GHz and a maximum detection frequency of 448 GHz.

# 3. DETECTOR DESIGN

LiteBIRD will deploy two detector architectures to optimize the overall sensitivity of the experiment as shown in Figure 4. The **LFT** and **MFT** will deploy lenslet-coupled sinuous antenna **TES** bolome-

ter arrays and the [HFT](#) will deploy horn-coupled OMT [TES](#) bolometer arrays. The details of each detector architecture are shown in figure 4. The arrays are fabricated at the [MNL](#) at [UC Berkeley](#) and the [BMF](#) at [NIST](#). Due to the commonality of many of the RF and bolometric components of the array architectures the fabrication of all of the arrays is quite similar even when comparing the fabrication flow for sinuous antennas and [OMTs](#).

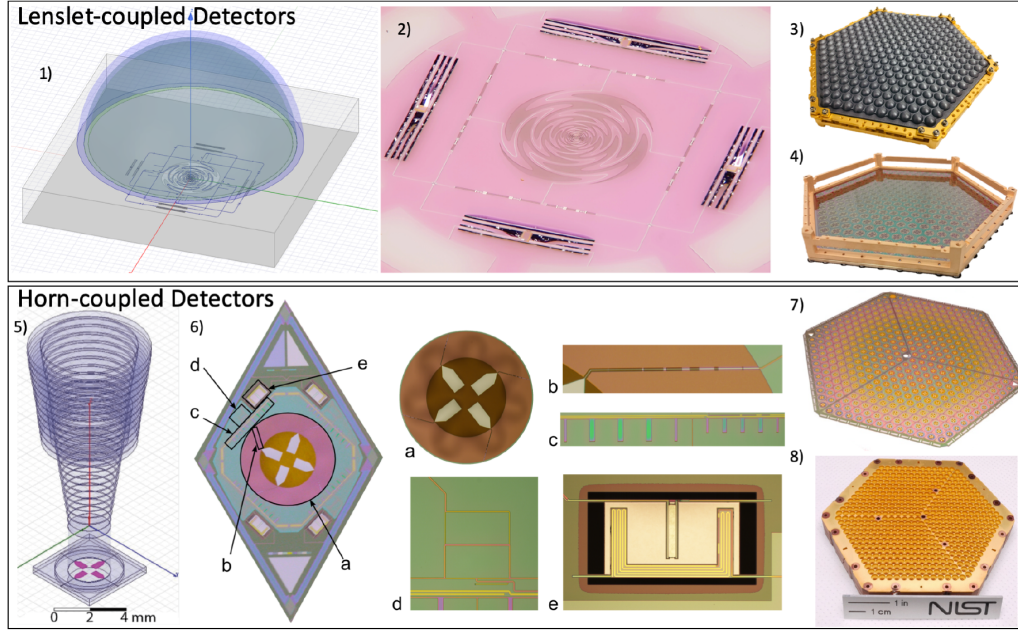


Figure 4. LiteBIRD detector arrays consist of lenslet-coupled arrays for the [LF-FPU](#) and [MF-FPU](#) and horn-coupled detector arrays for the [HF-FPU](#). 1) Single lenslet-coupled detector. 2) Photograph of microfabricated sinuous antenna coupled detector. 3) Machined monolithic silicon lenslet array and 4) microfabricated detector array in a gold plated detector holder. 5) Single horn-coupled detector. 6) Optical micrograph of detector with labeled components a) planar OMT, b) [CPW](#) to microstrip transition, c) diplexer, d) 180 hybrid, e) [TES](#) bolometer. 7) Photograph of 432 element array of dichroic horn-coupled detectors and mating 8) silicon platelet feedhorn array.

### 3.1 Lenslet Coupled Sinuous Antenna Arrays

A contact lens placed near a planar antenna increases the forward gain of the antenna and is a technique used in mm and sub-mm astronomy for many years. Panel 1 of figure 4 shows a [High Frequency Simulation Software \(HFSS\)](#) simulation setup of a lenslet placed over a LF-4 pixel. The lenslet coupled double slot dipoles have been deployed by the [POLARBEAR](#)<sup>4</sup> to measure E-modes and constrain the sum of neutrino masses. More recently lenslet-coupled sinuous antenna arrays have been deployed by the [SA](#) and [South Pole Telescope Third Generation \(SPT-3G\)](#). In the case of [SA](#) the detectors are dichroic 90/150 *GHz* pixels and in the case of [SPT-3G](#) the detector arrays are trichoric 90/150/220 *GHz* detectors.<sup>9,10</sup>

Sinuous antennas are broadband log-periodic self-similar antennas sensitive to polarization. The log periodic nature of the antenna makes it ideal for the broad frequency coverage required by the LiteBIRD science goals. This technology is being deployed by the [SA](#) and [SPT-3G](#) and will be

deployed by the [SO](#).<sup>9–11</sup> The broadband nature of these antennas are well suited for the LiteBIRD mission, especially for the [LFT](#) and [MFT](#) where 11 of the 15 LiteBIRD bands are located.

The log-periodic nature combined with inherent chirality of the sinuous antenna give rise to a small polarization rotation as function of frequency that can change within the bandwidth of a single LiteBIRD band. The amplitude of this effect will be measured for all of the LiteBIRD bands. Furthermore, we address this systematic effect by carefully choosing the orientation of the sinuous antennas that populate a [FPM](#). We align the two axes of a sinuous antenna to the Q and U stokes parameters. We call the sinuous antennas with their micro-strips crossing at 0/90 degrees “Q” pixels and sinuous antennas with their micro-strips crossing at 45/135 degrees “U” pixels. For each of these pixel types we populate the focal plane with roughly half “A” type and “B” types, where type “B” is a mirror image of type “A” creating a natural cancellation of this rotation effect as shown in figure 5.

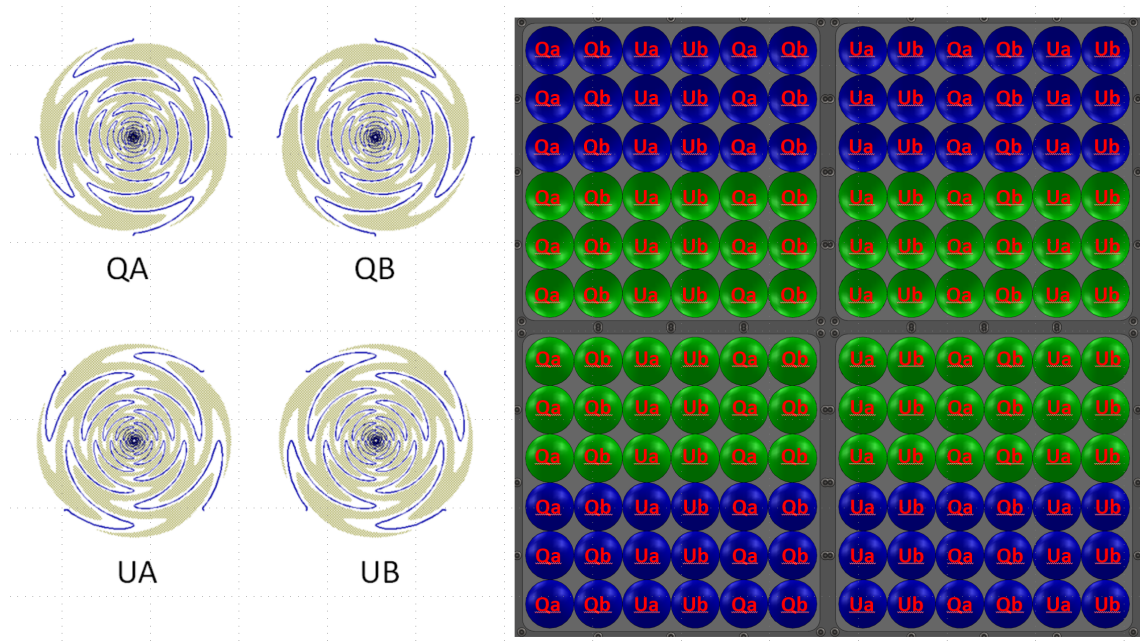


Figure 5. A schematic of the four pixel orientations per pixel type in LiteBIRD. For [LF](#) the numerology is such that there is an exactly equal count of each pixel orientation. For the [MF FPM](#). Each module as 61 pixels and therefore each will have one additional “Qa” pixel per module. All of the pixels in the [HFT](#) are [OMTs](#) and therefore do not require this mitigation technique.

In addition to implementing this polarization rotation cancellation directly into the wafer design, the parameters that control the shape of the sinuous antenna can also be used to reduce the amplitude of the wobble, which makes this effect even more negligible.

### 3.2 Horn Coupled Orthomode Transducer Technology

Feedhorn coupled [OMTs](#) are widely used for studies of the polarization of the [CMB](#) as well as many other radio astronomy experiments.<sup>6,8,12</sup> In most modern experiments the feedhorns are either

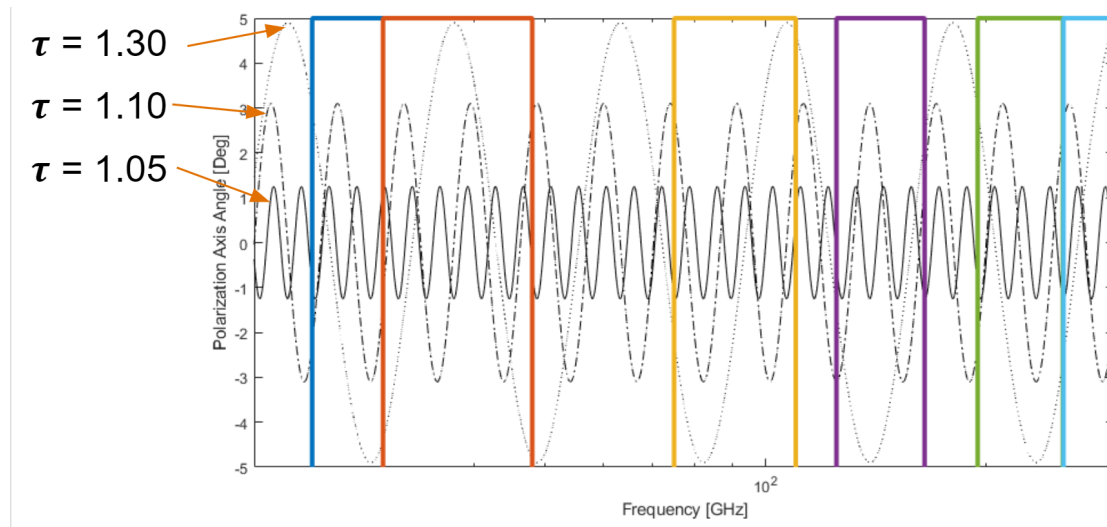


Figure 6. A graph showing the amplitude of the sinuous antenna polarization rotation for three different values of  $\tau$  over plotted with fiducial CMB experiment's bands. At lowest  $\tau$  studied, 1.1 one can see that the rotation effect is averaged down in any given bands as the rotation oscillated many times over a typical CMB band when  $\tau$  is low.

corrugated and/or have a spline profile which have nearly Gaussian beam profiles and have very small temperature to polarization (T to P) leakage over a large bandwidth.<sup>13</sup> The feedhorns also have excellent flexibility with respect to beam size and do not require any AR coatings, which can be especially challenging at the highest frequencies of LiteBIRD.

The light coming through the feedhorn is coupled to four planar niobium OMT probes suspended on a low stress silicon nitride membrane. Each pair of Nb probes separate the orthogonal polarization components and couple them to separate CPW transmission lines. The CPWs are converted in to Nb micro-strip transmission lines and then split by stub filters into two distinct bands (see section 3.2.1). The power from each polarization and each band is sensed by a TES suspended on a bolometer island.

### 3.2.1 RF Components

The details of the Radio-Frequency (RF) components vary from band to band and pixel to pixel, but the paradigm is the same for all of the pixels in LiteBIRD as all of the arrays define the pass-bands directly on the wafer using a combination of CPW, low-loss superconducting micro-strip transmission lines, on wafer pass-band definition, cross-unders for orthogonal polarizations, and RF termination at the bolometer island. For LiteBIRD the CPWs and micro-strip lines are constructed with Niobium and a low-loss SiNx layer. We pattern traditional RF circuit elements to the transmission lines to create the designed passbands. Table 2 summarizes the band centers and fractional bandwidths ( $\Delta\nu/\nu$ ) for all of the LiteBIRD bands, which is typically  $\sim 30\%$ . An example layout and simulated band passes for LF-2 are shown in figure 7. Simulation work is also complete for all of the other LF LiteBIRD pixel types and fabrication and testing of these RF structures is underway. Initial results can be found in section 5.



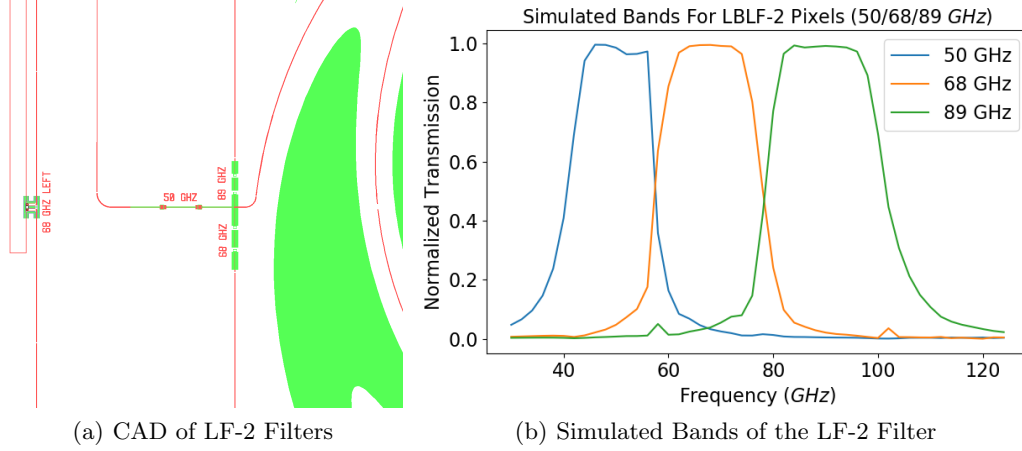


Figure 7. A gds layout of the LF-2 triplexing filter with band centered on 50, 68, and 89  $GHz$ . The right hand side shows the bandpasses simulated in Sonnet for these three LiteBIRD bands.

### 3.3 TES Bolometers

The designs for the [TES](#) bolometers are quite similar for all 15 detector types due the fact that they share a common operating temperature and readout scheme. The thermal conductance is tuned to the expected optical load and then the heat capacity of each detector type is tuned so that all of the detectors have the same  $\tau_0$  of 33  $ms$ . The details of each band and expected optical power are shown in table 2 and a summary of all of the common optical and bolometric parameters are show in table 3. These are preliminary values, but we expect these to carry through with little or no change.

#### 3.3.1 Interface to Cryogenic Readout

The same niobium layer that forms the micro-strip layer is also used to route the [TES](#) bias/readout leads to the edges of the wafer to interface with the readout. For the [LF FPMs](#) wiring density is low compared to ground-based arrays allowing for all of the [TESs](#) to be readout on a single side allowing for more flexibility with the design of the [Cryogenic Readout \(CR\)](#) interface. For the [MF](#) and [HF FPMs](#) the wires are routed to all of the edges of the wafer for bonding.

#### 3.3.2 Cosmic Ray Mitigation

Cosmic ray mitigation is integrated directly into the focal plane design to limit cosmic ray impacts on low- $\ell$  systematics and data loss. The transient energy deposition of cosmic rays interacting with the spacecraft can create glitches in the time-stream of data sent to the readout. It is known from the Planck mission that long time scale glitches are produced when cosmic rays interact with the silicon die and short pulse-like glitches result from interactions close to the thermistor.<sup>14</sup> This has yielded a strategy of increasing thermal conductivity between the silicon die and the focal plane structures to reduce long time scale thermal fluctuations and blocking phonon propagation to the [TES](#) for the short glitches. To accomplish this we deposit a layer of Pd over the entire wafer where it does not interfere with the optical path nor with the Nb wiring. Progress in the lab has been made blocking the ballistic phonons near the [TES](#) by removing and adding metal layers and etching silicon. Examples of these mitigation structures are shown in figure 8.

In parallel to mitigation solutions, we are developing an end-to-end simulation tool to address the

Index	Band Center (GHz)	FPU	FPM	$N_{det}$	Pixel Size (mm)	$\Delta\nu/\nu$	Optical Load (pW)	$NET_{arr}$ ( $\mu K\sqrt{s}$ )
1	40	LF	LF12	48	32	0.30	0.2918	114.63
2	50	LF	LF12	24	32	0.30	0.306	72.48
3	60	LF	LF12	48	32	0.23	0.2419	10.54
4	68	LF	LF12	24	32	0.23	0.2709	15.70
		LF	LF34	144	16		0.3279	9.84
5	78	LF	LF12	48	32	0.23	0.2686	9.46
		LF	LF34	144	16		0.3272	7.69
6	89	LF	LF12	24	32	0.23	0.2958	14.22
		LF	LF34	144	16		0.3163	6.07
7	100	LF	LF34	144	12	0.23	0.3061	5.11
		MF	MF1	366	12		0.3559	4.19
8	119	LF	LF34	144	12	0.23	0.3765	3.82
		MF	MF2	488	12		0.4386	2.82
9	140	LF	LF34	144	12	0.30	0.3557	3.58
		MF	MF1	488	12		0.4206	3.16
10	166	MF	MF2	488	12	0.30	0.3908	2.75
11	195	MF	MF1	366	12	0.30	0.3572	3.48
		HF	HF1	254	6.6		0.6289	5.19
12	235	HF	HF2	254	6.6	0.30	0.4708	5.34
13	195	HF	HF1	254	6.6	0.30	0.3770	0.682
14	337	HF	HF2	254	6.6	0.30	0.2997	10.85
15	402	HF	HF3	338	5.7	0.23	0.2203	23.45

Table 2. Details of detector properties for all of the bands in LiteBIRD. Some bands are present in each of the **FPUs** to further mitigate systematic effects from the different telescopes. There are two detectors per band for each polarization. The saturation power of the detectors is set to be  $2.5 \times P_{opt}$ .

potential impact of cosmic rays on the data. The thermal impact of the particles is simulated in COMSOL assuming the cosmic ray environment at L2 as observed by PAMELA in 2009.<sup>15</sup> Thermal fluctuations of the wafer temperature, which is considered to be the bath temperature seen by the detectors, are then fed to a python routine\* which simulates the detector response assuming a DC-biased configuration according to the model described in.<sup>16</sup> Although we expect different optical loading depending on the observing frequency, for simplicity we are assuming a typical optical loading of  $\sim 0.5$  pW. From this value we fix the saturation power to  $\sim 2.5$  times the optical power, and by assuming a detector intrinsic time-constant of 33 ms we can define all parameters needed for the simulation. After computing the current response of the detector in the high loop gain limit ( $\mathcal{L} \sim 10$ ) we convert the current to input power from the current responsivity in this limit  $S_I \sim -1/V_b$ . The generated detector timestream, for 12 **TES** on each wafer, is then fed to a satellite simulation pipeline developed for LiteBIRD (TOAST-LiteBIRD). The final results are  $TT$ ,  $EE$ , and  $BB$  for each frequency band, for 12 **TES**, of only the cosmic ray effect. Using this end-to-end simulator, we plan to probe various design changes (e.g. the addition of Au wirebonds to the periphery of the wafer) in order to optimise LiteBIRD's mitigation of cosmic rays.<sup>17</sup>

\*<https://github.com/tomma90/tessimdc>



Design	Goal
Pixel in-band optical efficiency	$\geq 80\%$
Minimum Operating Power	2-3X optical power
On-sky end-to-end yield	$\geq 80\%$
FPU $T_b$	100 $mK$
Cross wafer $T_c$ variation	$\leq 7\%$
TES operating resistance	0.6 to 0.8 $\Omega$
Parasitic series resistance	0.05 to 0.2 $\Omega$
Intrinsic Time Constant ( $\tau_0$ )	33 $ms$
Loopgain during operation	$\geq 10$
Common 1/f-knee	$\leq 20 mHz$
FPU lifetime	$\geq 3$ years

Table 3. A summary of the common optical and bolometric design goals of the LiteBIRD detectors. We expect that there will be little deviation from these goals during the development of the FPUs for LiteBIRD.

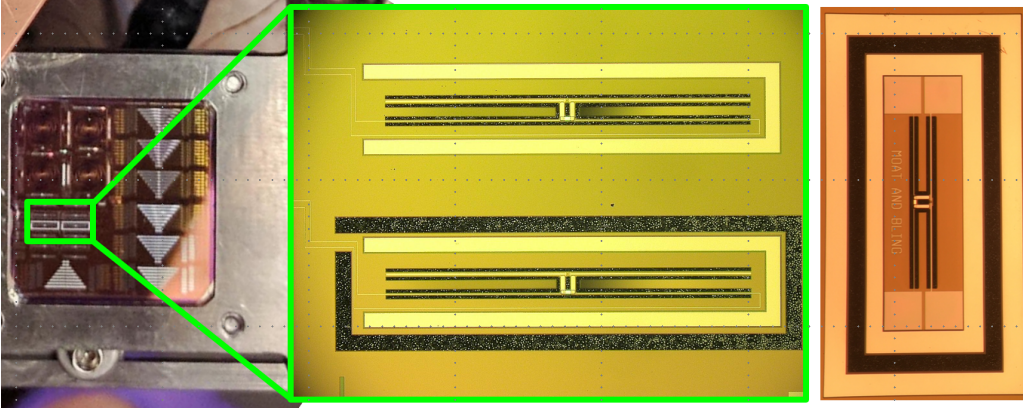


Figure 8. A photograph a cosmic ray mitigation test chip (left) and micro-graphs of a three example TES bolometers with cosmic ray mitigation structures (middle and right). The top bolometer is surrounded with a layer of palladium and the bottom bolometer has both a surrounding ring of Pd as well as a vacuum "moat" where the silicon surrounding the bolometer is etched away using XeF2. The bolometer on the right including both of these mitigation techniques but is completely surrounded.

## 4. FABRICATION

LiteBIRD requires a total of 18 flight quality wafers to meet the sensitivity requirements. The responsibility of these wafers is split between the MNL at UC Berkeley and the BMF at NIST. UC Berkeley will fabricate the 8 LF wafers as well as the all of lenslet arrays for the LF-FPU and the MF-FPU. NIST will fabricate the MF and HF detector arrays and the feedhorn array for the HF-FPU.

### 4.1 Sinuous Antenna Fabrication

Although there are differences between the fabrication flow of sinuous antenna bolometers at MNL and BMF, we only describe the fabrication process for the sinuous antennas at UC Berkeley<sup>7</sup> to build a prototype LF-4 array. NIST has also completed the design and fabrication of a LF-1 prototype pixel as shown in Figure 9.

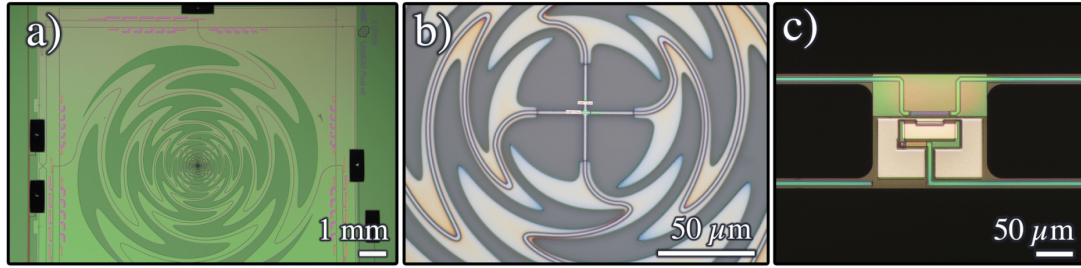


Figure 9. Micrographs of a LF-1 prototype pixel (a), the center of the sinuous antenna (b), and a TES bolometer island (c). This pixel was fabricated at NIST and tested at CU. A beammap of this pixel is shown in Figure 14

In the UC Berkeley fabrication process flow starts with six inch p-doped 10-30  $\Omega$ -square wafers that have had deposited a 600 nm structural film of low pressure chemical vapor deposition (LPCVD) low Stress nitride (LSN), with a buffer layer of 35 nm thermal oxide. From there, a Nb ground plane, is sputter deposited on the LSN surface with a film which is stress tuned to a compressive stress of  $\geq -200$ . The tool dedicated to depositing the superconducting Nb, an MRC-943, is also used to deposit the TES AlMn (aluminum manganese) metal. The tool is used for these metals only, providing a high level of process control over the material properties and uniformity of these films. A base pressure in the low 10E-7T's is maintained, with partial pressures of H<sub>2</sub>O, OH, and N<sub>2</sub> into the 10E-8T's. Cross wafer uniformity of sheet resistance for the Nb and AlMn is 2.5% and 1.8% respectively, with a wafer-to-wafer deviation of less than 1%.

All photolithography is performed using a GCA-8500 I-line stepper with the exception of Nb wiring from the bond pads to the TESs, for which a contact aligner is used. The Nb etching is performed with a LAM TCP metal etcher using a chlorine chemistry. By removing the typical BCl<sub>3</sub> co-flow of gas, a high degree of selectivity can be achieved over both the structural LSN to Nb ground plane, and dielectric nitride to Nb microstrip. Once the wafers exit the TCP etcher, they are immediately quenched with de-ionized (DI) water to clean away any residual Cl<sub>2</sub> from the etch that would otherwise react with the water in the atmosphere to create HCl which damages the grain boundaries Nb, leading to loss of optical efficiency.

The next step is to deposit the dielectric silicon nitride (SiN<sub>x</sub>) layer for the microstrip using a plasma enhanced chemical vapor deposition (PECVD) process using an Oxford Plasmalab System 100. While typical recipes for PECVD nitride use some ratio of SiH<sub>4</sub> (Silane) and NH<sub>3</sub> (ammonia) to deposit the SiN<sub>x</sub> film, an ammonia-less recipe was developed using a ratio of 1000:15 standard cubic centimeters per minutes (SCCMs) of N<sub>2</sub>:SiH<sub>4</sub>. By removing NH<sub>3</sub> from the reaction, with the nitrogen coming from simple nitrogen gas, the hydrogen contaminant from precursor gas is greatly reduced, leading to less lossy dielectric.<sup>18</sup>

Once the dielectric deposition is complete, construction of the TES bolometer island begins with the Ti (titanium) load resistor. A 40 nm film of Ti is deposited in a tool named MRC944, which is nearly identical to the MRC943 and benefits from the same high vacuum purity and repeatability process chamber with a cross wafer uniformity of 2%. The titanium load resistor is etched using the same LAM TCP metal etcher with a SF<sub>6</sub>/O<sub>2</sub> chemistry. An in-situ, optical absorption end point detector is used to terminate the etch once the reactive gases etch through the Ti and reach the dielectric layer.

Next a 90 nm film of AlMn, using the MRC943, is deposited which is then lithographed and patterned into the TES. The etch is performed with a Phosphoric, Acetic, Nitric (PAN) acid aluminum wet etch at 50°C. The next step is to thermally tune the TESs for 10 minutes using a Wencesco vacuum hot plate which ensures a uniform thermal distribution across the wafer. A baking temperature of 188°C was determined to produce a superconducting transition temperature of 160 mK in 90 nm AlMn films appropriate for LiteBIRD TESs 12(d).<sup>19</sup>

Once the Ti load resistor and TES elements have been patterned, they are then protected by a 150 nm silicon nitride passivation layer. This is accomplished using a low temperature (25 °C) electron cyclotron resonance (ECR) based low pressure (10 mT) PECVD which ensure that the  $T_c$  of the TESs is not changed by this process. This passivation layer is patterned and etched using a LAM Oxide Rainbow etcher with CF<sub>4</sub>/O<sub>2</sub> chemistry, such that the bulk of the Ti load resistors and TESs remain protected, with openings for electrical connection to the forthcoming Nb micro-strip and wiring layer.

The MRC943 is used again for the Nb sputter deposition, which forms the micro-strip and wiring. A sputter etch of the exposed Ti and AlMn ensures that native oxides are removed and a direct metal to metal contact is made. After the micro-strip, wiring and antenna are lithographically defined, the LAM metal etcher patterns the structures into the Nb.

The final layer to process is the thermal ballasts to tune the time constant of the bolometers to the readout bandwidth of the CR. We chose Pd (palladium) for its high thermal capacitance at low temperatures. This layer is patterned using a liftoff process which defines the structures with a 10 nm Ti adhesion layer and 1.0 μm of Pd.

The final step is to thermally isolate the bolometer island from the bulk silicon substrate. This is accomplished by etching through the remaining LSN around the bolometer, to the silicon substrate. The wafer is diced into its final shape before being etched in an isotropic XeF<sub>2</sub> vapor etch chamber that leaves the bolometer structure suspended and thermally isolated by etching the silicon substrate from underneath the bolometers. The buried thermal oxide layer, with its 1:1000 oxide to silicon selectivity, minimizes the amount of structural LSN consumed during the etch release from the silicon substrate. The final step is to ash away the photoresist that was protecting the metal detector elements from the XeF<sub>2</sub> etch. A photograph of a completed array and bolometer is shown in figure 10.

## 4.2 OMT Fabrication

The OMT-coupled detector arrays are fabricated in the Class-100 NIST BMF cleanroom. The fabrication process for the OMT detector arrays borrows heavily from the processes developed at NIST for the high frequency 150/220 GHz Advanced ACTPol array.<sup>8,20</sup> A 150 mm silicon (100) wafer is coated with 450 nm thermal SiO<sub>2</sub> and 1 μm LPCVD low-stress SiN<sub>x</sub>, which together form the membranes that suspend the bolometer and OMT probes, as shown in figure 11(a). Additionally, the SiO<sub>2</sub> acts as the etch stop for the deep reactive ion etching (DRIE) step. All frontside patterning is completed with a dedicated 150 mm stepper, allowing for non-contact pattern transfer of every lithographic component.

The Nb ground plane and first wiring layer are sputter deposited, lithographically patterned, and plasma etched using a SF<sub>6</sub>/O<sub>2</sub> ICP-RIE process. Next, the AlMn-alloy TES is sputter deposited, lithographically patterned, and wet etched with Transene Type A etchant heated to ~50°C. The patterned AlMn TES is annealed to ~230°C in air to set  $T_c$  to the specified target of 160 mK.

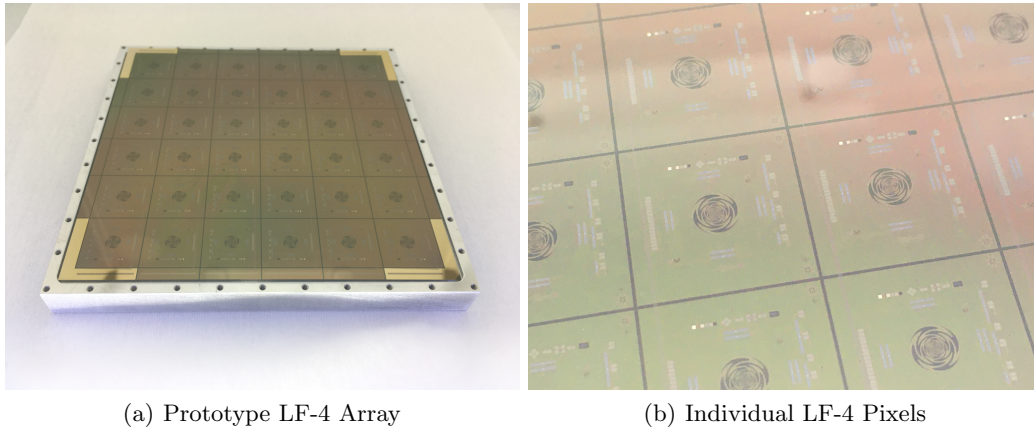


Figure 10. Photographs of a LF-4 prototype array (a) and pixels (b).

A SiNx dielectric layer, used for the microwave transmission lines, is deposited via [PECVD](#), lithographically patterned, and etched in a CF<sub>4</sub>-based ICP-RIE plasma. The second Nb wiring layer, also used as the top microstrip conductor, is then sputter deposited, lithographically patterned, and plasma etched using a SF<sub>6</sub>-based ICP-RIE process. The RF termination is a meandering line of Ti/Au that is lithographically patterned for a liftoff process prior to an electron-beam evaporative deposition. A passivating SiNx dielectric layer is deposited with [PECVD](#), then is lithographically patterned, and etched using a CF<sub>4</sub>-based ICP/RIE etch. PdAu thermal ballasts are added to the bolometer island by lithographically patterning for a liftoff process and sputter depositing the PdAu, which is chosen for its relatively high heat capacity. The bolometer leg geometry is defined by performing a frontside punch-through CF<sub>4</sub>-based ICP-RIE etch of all SiNx ([PECVD](#)-deposited and [LPCVD](#)-grown) and thermal SiO<sub>x</sub>.

The backside processing includes the blanket removal of both [LPCVD](#) SiNx and thermal oxide via SF<sub>6</sub>-based ICP-RIE etch. This allows for a backside liftoff process of electron-beam evaporated Ti/Au, which acts as a thermal heat sink in direct contact with the silicon wafer. Finally, the backside is lithographically patterned for the [DRIE](#) step, which both thermally isolates the bolometers from the silicon substrate via four SiNx legs and forms the SiNx/SiO<sub>x</sub> membrane on which the [OMT](#) probes are situated.

The [NIST](#) fabrication team has started on the production of prototype pixels for the [HFT](#). Single pixel prototypes for the HF- are HF-2 bands have been fabricated and testing is ongoing. Figure [11\(a\)](#) shows a micrograph of a completed LiteBIRD HF-1 pixel and figure [11\(b\)](#) shows a sampling of the accompanying prototype HF [TES](#) bolometers.

## 5. TESTING

### 5.1 UC Berkeley

[UC Berkeley](#) has primary responsibility for the characterization of the [LF-FPUs](#) as well as the assembled [LF-FPU](#). This will be carried in a BlueFors LD400 [Dilution Refrigerator \(DR\)](#) recently installed at UCB for the development of LiteBIRD detectors. A photograph of this test-bed is shown in figure [12](#).



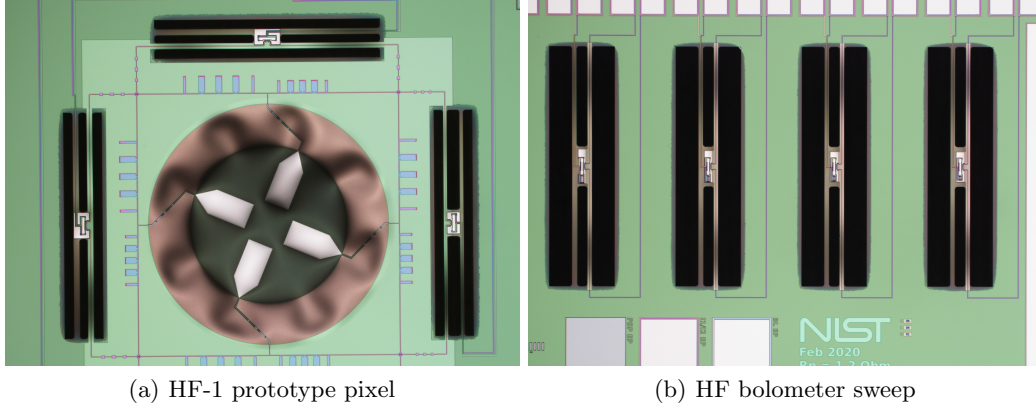


Figure 11. Micrographs of a HF-1 prototype pixel (a) and several iteration of TES bolometers designs (b) fabricated at NIST and to be tested at Stanford.

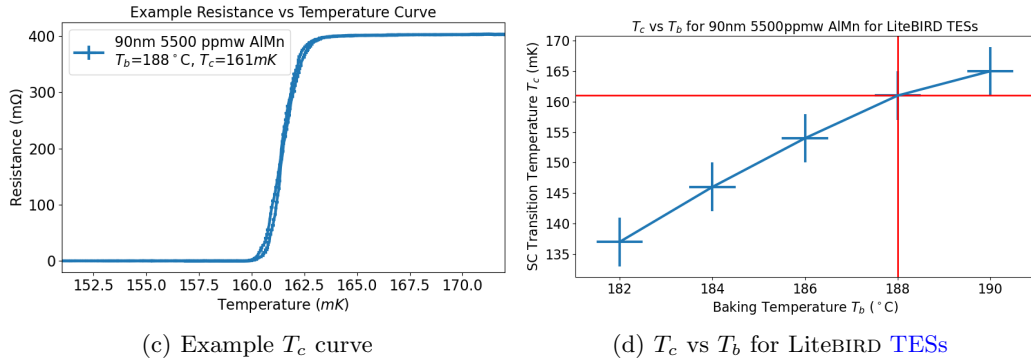
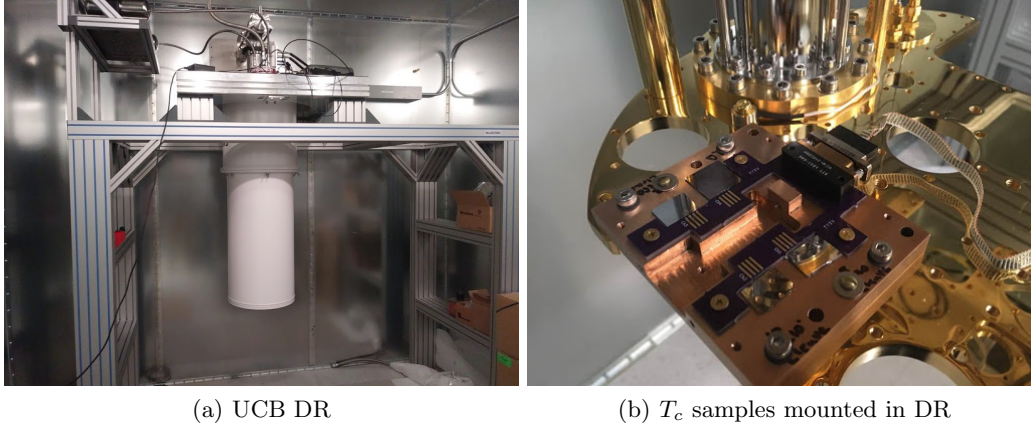


Figure 12. A photograph of the UCB DR (a),  $T_c$  samples mounted in the DR (b), and the resulting  $T_c$  vs  $T_b$  curve (d). We thermally tuned five different 90 nm films of 5500 ppmw DC sputtered AlMn. We find that a baking temperature of 188 °C yields a superconducting transition temperature of  $161 \pm 2$  mK.

This 100 mK capable test bed is used for quick feed back of transition temperatures of the TES films as shown in figure 12(d). Based on heritage from building digital frequency-domain multiplexing (DfMux) appropriate TES sensor for the SA, the UC Berkeley fabrication team chose 90 nm films as the thickness for the LiteBIRD TES of the LF-FPUs. A wafer with the same substrate as device wafer had 90 nm of AlMn deposited via DC magnetron sputtering. It was singulated into 1x1 cm squares, which were then thermally tuned at 5 different temperature ranging from 182 to 192°C. A baking temperature of 188 °C yielded a  $T_c$  of 160 mK which is the target specification for these TESs.

#### 5.1.1 Cosmic Ray Mitigation

Tests with radioactive sources in the lab have shown phonon blocking effects by interrupting the phonon conduction paths to the TES.<sup>21</sup> 5.49 MeV alpha particles from an Americium-241 source are used for measurements probing phonon propagation across the surface of the detector chips. To probe ballistic phonon propagation through the bulk silicon, a Cobalt-60 source, providing > 1 MeV gammas, is used. While the cobalt source can be placed outside of the dewar due to the highly penetrating gammas, the alpha particles from the Americium source will deposit almost all of their energy in the top layers of the device wafer. Because of this, the alpha source is mounted inside the cryostat with our detector chip in an invar assembly that allows for precise positioning of the source over the bolometers. The alpha source can be placed over a collimator which allows for illumination of specific components of the device wafer when desired. Bolometers underneath the source are arranged in a grid pattern to test both interaction distance as well as various mitigation. They are read out using a DC Superconducting Quantum Interference Device (SQUID), a pre-amplifier with a low pass filter and digital-to-analog converter (DAC) sampling at 6 kHz. The resulting data is then fit using a matched filter peak finder and a second order polynomial in log-space as shown in figure 13.

### 5.2 CU Boulder

The CU is responsible for testing and characterization of the Mid-Frequency Focal Plane Modules (MF-FPMs). The CU test bed is a 100 mK 2-stage ADR and has a heritage of testing detectors for South Pole Telescope Polarization Experiment (SPT-Pol), SPT-3G, POLARBEAR, and SA. The team has characterized LiteBIRD prototype "V0" LF-1 pixels and TES bolometers fabricated for LiteBIRD research and development. characterized low-frequency pixels. The lab has a six-axis beam mapper and Fourier Transform Spectrometer (FTS) for detailed optical measurements of band and beam shape. Figure 14 shows details of the experimental setup and a beammap of 40 GHz LF-1 bolometer.

Recently, the fabrication team at NIST finished HF-1 pixels which are slated to be tested at CU in the coming months.

### 5.3 Stanford

Stanford has primary responsibility for optical characterization of the high frequency FPMs. Sensitivity, polarization efficiency, feed pattern, spectral response, and temporal response will all be measured. The Stanford team also has primary responsibility for development of the FPU structures, and thus for testing the launch survival (at room temperature) of the units as well as microphonic transmission of representative units at cryogenic temperature. A shake table at Space Sciences Laboratory (Berkeley) will be used for launch survival testing, both of breadboard models and engineering models. Microphonics, as well as thermal loading and dimensional stability, will be measured and verified in-house.

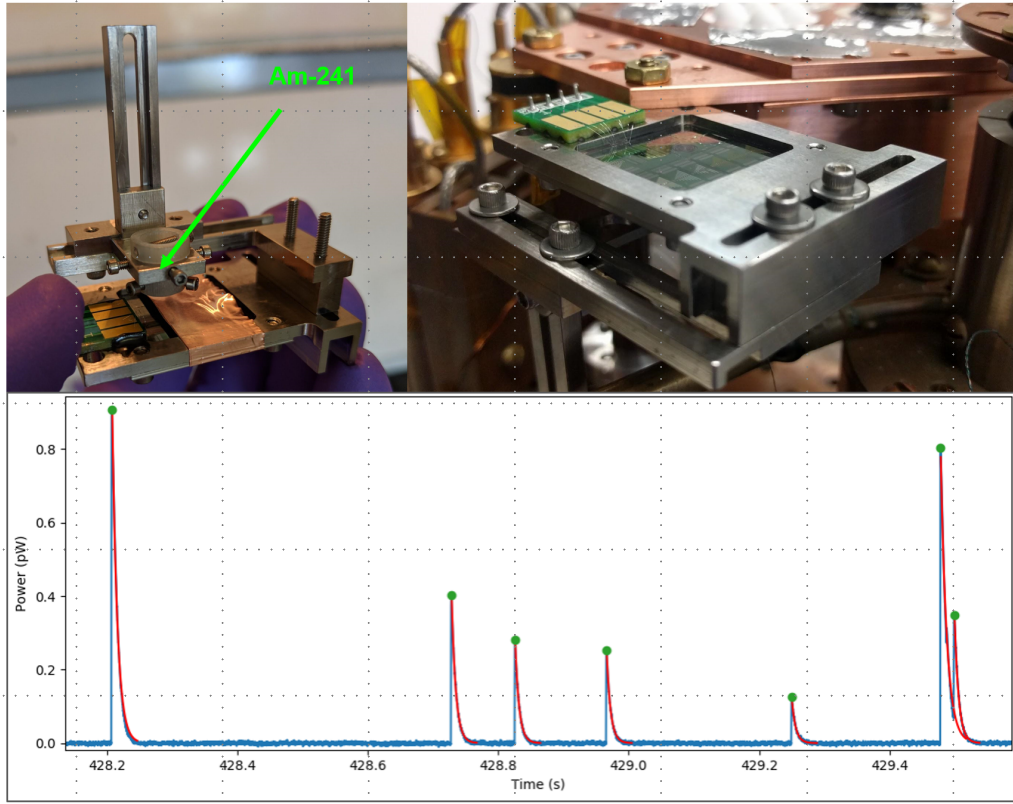


Figure 13. A photograph of the cosmic ray mitigation setup at [UC Berkeley](#). Americium-241 is placed just above the [TES](#) bolometers with the various mitigation structures shown in figure 8. An example timestream of a bolometer measuring signals from cosmic ray like radiation from a Am-241 source over at  $\sim 2$  second period.

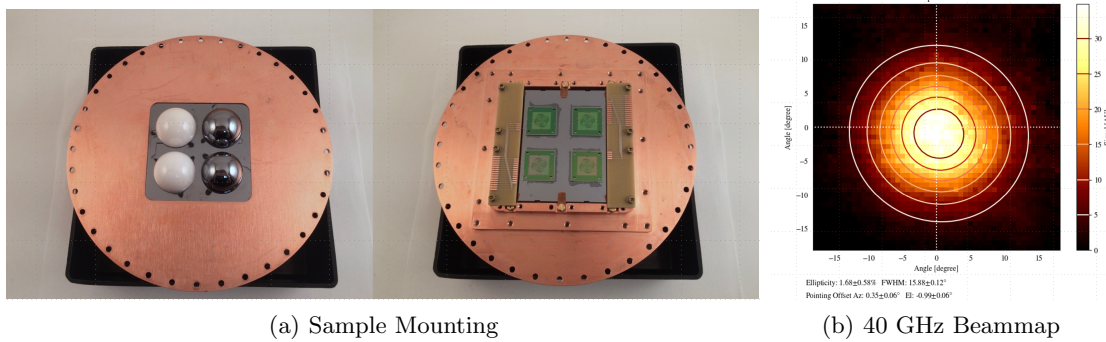


Figure 14. A photograph of the [CU](#) cold stage (top), a photograph of LF-1 pixels mounted with lenslets, and a plot of a beammap of 40 *GHz* bolometer.



## 6. SUMMARY

In these proceedings, we report on the status of the US collaboration’s contribution to the LiteBIRD satellite mission which will map the polarization CMB over the entire sky and constrain  $\delta r \leq 0.001$ . The US will deliver three FM quality FPUs, for each of the mission’s three telescopes as a core contribution to the payload. The detector arrays will be fabricated at UC Berkeley and NIST and will be tested at Stanford, CU, and UC Berkeley with help from collaborators at other LiteBIRD institutions.

Initial measurement of LiteBIRD prototypes show that our designs to adapt ground based technology to a space environment is possible with further technical development. We built and characterized triplexing lenslet coupled sinuous antenna pixel appropriate for the LF-FPU with appropriate bandwidth in each band. In addition, we have characterized bolometers with correct  $T_c$  and  $R_n$  that meet the thermal-carrier noise requirements of the detection chain. We have designed and simulated many of the LiteBIRD bands and have fabricated prototype pixels for the LF-FPU (LF-1 and LF-4) and HF-FPU (HF-1 and HF-2) pixel types and characterization is ongoing. Additionally, we are developing robust testing infrastructure and personnel training at all of the US LiteBIRD institutions to meet the testing demands of delivering FM FPUs to the mission.

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